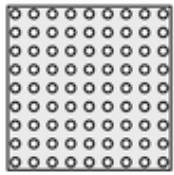
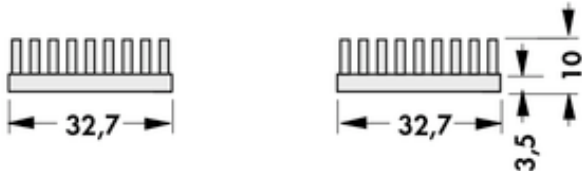
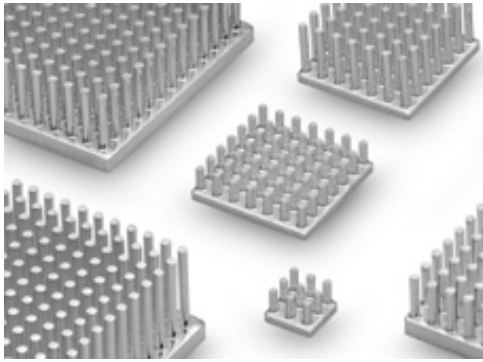


Pin heatsinks / **ICK S 32 x 32 x 10**

32 x 32 x 10 mm, pin heatsinks quadratic

Parameters of article ICK S 32 x 32 x 10

Bauform	Rechteck
R_{th} [K/W]	5.4
dissipation loss [W]	13.8
mounting method	therm. conductive foil / therm. cond. adhesive
socket	universal
suitable for processor type	universal
width [mm]	32.7
height [mm]	10
plate thickness [mm]	3.5
weight [g]	14
length on stock [mm]	32.7

Accessories/ related articles

Thermally conductive foil both sides adhesive / **WLFT 404 32 x 32**

Thermally conductive foil both sides adhesive / **WLFT 405 32 x 32**

